



Parameter	Rating	Units
Blocking Voltage	60	V <sub>P</sub>
Load Current	100	mA <sub>rms</sub> / mA <sub>DC</sub>
On-Resistance (max)	16	Ω
LED Current to operate	1	mA

### Features

- Designed for Use in Security Systems Complying with EN50130-4
- Only 1mA of LED Current Required to Operate
- 1500V<sub>rms</sub> Input/Output Isolation
- Small 4-Lead SOP Package
- TTL/CMOS Compatible Input
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Immune to Radiated EM Fields
- SMD Pick & Place, Wave Solderable
- Tape & Reel Version Available

### Applications

- Security
  - Passive Infrared Detectors (PIR)
  - Data Signalling
  - Sensor Circuitry
- Instrumentation
  - Multiplexers
  - Data Acquisition
  - Electronic Switching
  - I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation
- Aerospace
- Industrial Controls

### Description

The CPC1017N is a miniature single pole, normally open (1-Form-A) solid state relay in a 4-lead SOP package that employs optically coupled MOSFET technology to provide 1500V<sub>rms</sub> of input/output isolation. The super-efficient MOSFET switches and photovoltaic die use IXYS Integrated Circuits Division's patented OptoMOS architecture while the optically coupled output is controlled by a highly efficient GaAlAs infrared LED.

IXYS Integrated Circuits Division's state of the art double-molded vertical construction packaging enables CPC1017N to be one of the world's smallest relays. It offers board space savings of at least 20% over the competitor's larger 4-lead SOP relay.

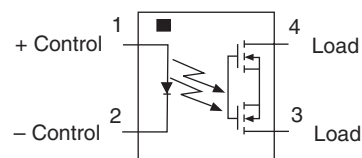
### Approvals

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component:  
TUV Certificate B 09 07 49410 004

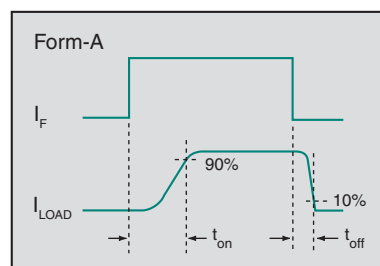
### Ordering Information

Part #	Description
CPC1017N	4-Lead SOP (100/tube)
CPC1017NTR	4-Lead SOP (2000/reel)

### Pin Configuration



### Switching Characteristics of Normally Open Devices



## Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	60	V <sub>P</sub>
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation	70	mW
Total Power Dissipation <sup>1</sup>	400	mW
Isolation Voltage, Input to Output	1500	V <sub>rms</sub>
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

<sup>1</sup> Derate linearly 3.33 mW / °C

*Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.*

## Electrical Characteristics @ 25°C

Parameter	Conditions	Symbol	Min	Typ	Max	Units
<b>Output Characteristics</b>						
Load Current						
Continuous <sup>1</sup>	I <sub>F</sub> =2mA	I <sub>L</sub>	-	-	100	mA <sub>rms</sub> / mA <sub>DC</sub>
Peak	t=10ms	I <sub>LPK</sub>	-	-	±350	mA <sub>P</sub>
On-Resistance <sup>2</sup>	I <sub>L</sub> =100mA	R <sub>ON</sub>	-	-	16	Ω
Off-State Leakage Current	V <sub>L</sub> =60V <sub>P</sub>	I <sub>LEAK</sub>	-	-	1	μA
Switching Speeds						
Turn-On	I <sub>F</sub> =5mA, V <sub>L</sub> =10V	t <sub>on</sub>	-	-	10	ms
Turn-Off		t <sub>off</sub>	-	-	10	ms
Output Capacitance	V <sub>L</sub> =50V, f=1MHz	C <sub>OUT</sub>	-	25	-	pF
<b>Input Characteristics</b>						
Input Control Current to Activate <sup>3</sup>	I <sub>L</sub> =100mA	I <sub>F</sub>	-	0.4	1	mA
Input Control Current to Deactivate	-	I <sub>F</sub>	0.3	-	-	mA
Input Voltage Drop	I <sub>F</sub> =5mA	V <sub>F</sub>	0.9	1.2	1.4	V
Reverse Input Current	V <sub>R</sub> =5V	I <sub>R</sub>	-	-	10	μA
<b>Common Characteristics</b>						
Capacitance, Input to Output	-	C <sub>I/O</sub>	-	1	-	pF

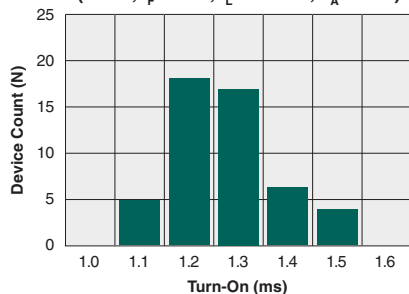
<sup>1</sup> Load current derates linearly from 100mA @ 25°C to 80mA @ 80°C.

<sup>2</sup> Measurement taken within 1 second of on-time.

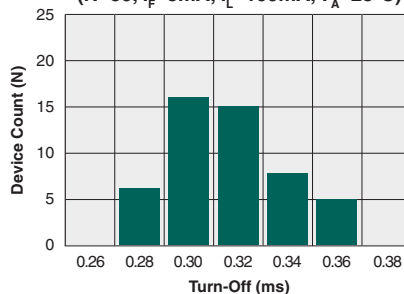
<sup>3</sup> For applications requiring high temperature operation (greater than 60°C) a LED drive current of 3mA is recommended.

# PERFORMANCE DATA\*

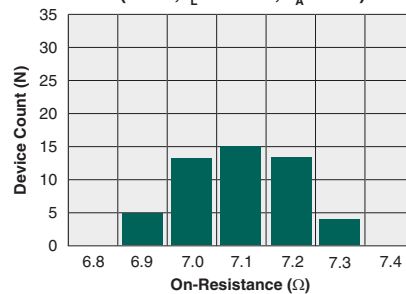
Typical Turn-On Time  
(N=50,  $I_F=5\text{mA}$ ,  $I_L=100\text{mA}$ ,  $T_A=25^\circ\text{C}$ )



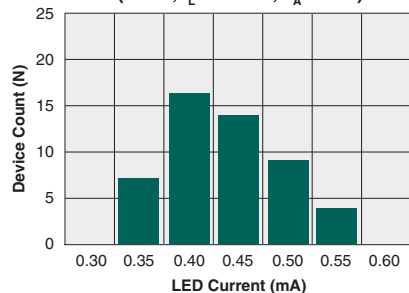
Typical Turn-Off Time  
(N=50,  $I_F=5\text{mA}$ ,  $I_L=100\text{mA}$ ,  $T_A=25^\circ\text{C}$ )



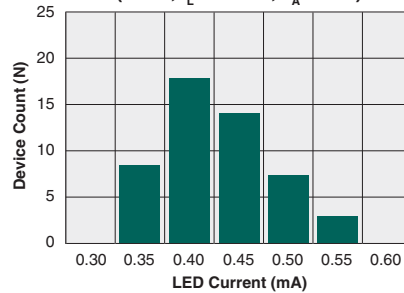
Typical On-Resistance Distribution  
(N=50,  $I_L=100\text{mA}$ ,  $T_A=25^\circ\text{C}$ )



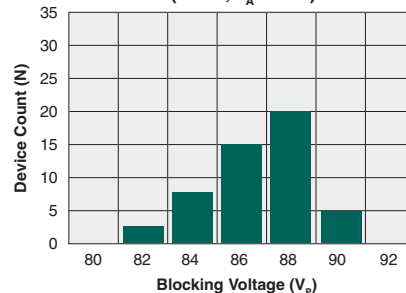
Typical  $I_F$  for Switch Operation  
(N=50,  $I_L=100\text{mA}$ ,  $T_A=25^\circ\text{C}$ )



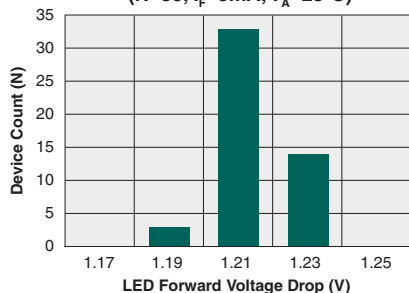
Typical  $I_F$  for Switch Dropout  
(N=50,  $I_L=100\text{mA}$ ,  $T_A=25^\circ\text{C}$ )



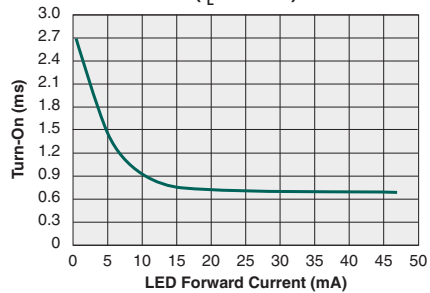
Typical Blocking Voltage Distribution  
(N=50,  $T_A=25^\circ\text{C}$ )



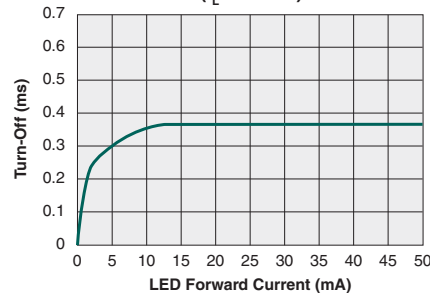
Typical LED Forward Voltage Drop  
(N=50,  $I_F=5\text{mA}$ ,  $T_A=25^\circ\text{C}$ )



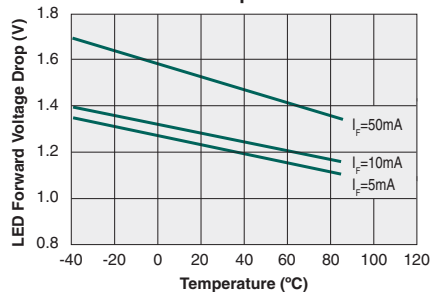
Typical Turn-On  
vs. LED Forward Current  
( $I_L=100\text{mA}$ )



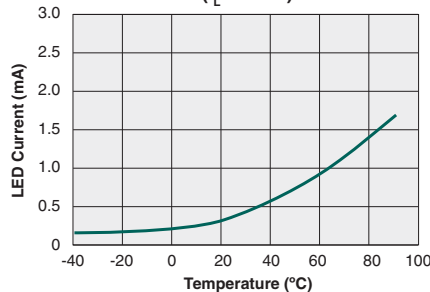
Typical Turn-Off  
vs. LED Forward Current  
( $I_L=100\text{mA}$ )



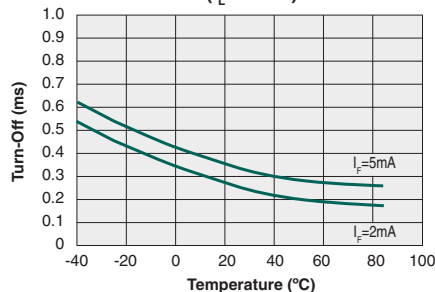
Typical LED Forward Voltage Drop  
vs. Temperature



Typical  $I_F$  for Switch Operation  
vs. Temperature  
( $I_L=80\text{mA}$ )



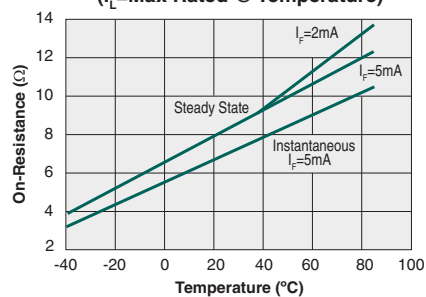
Typical Turn-Off vs. Temperature  
( $I_L=50\text{mA}$ )



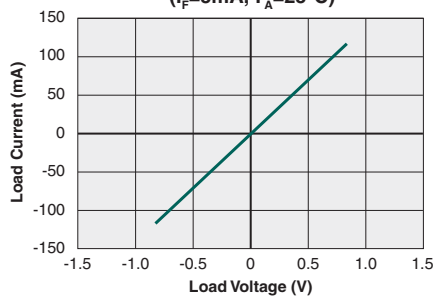
\*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

## PERFORMANCE DATA\*

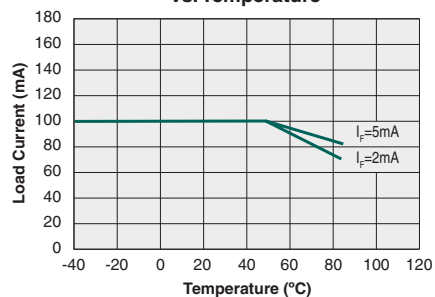
**Typical On-Resistance vs. Temperature**  
( $I_L$  = Max Rated @ Temperature)



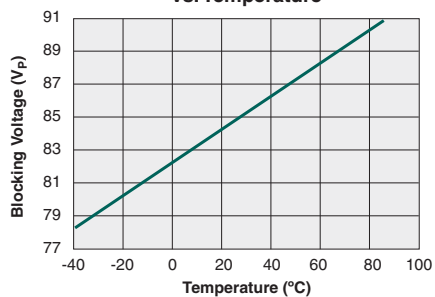
**Typical Load Current vs. Load Voltage**  
( $I_F = 5\text{mA}$ ,  $T_A = 25^{\circ}\text{C}$ )



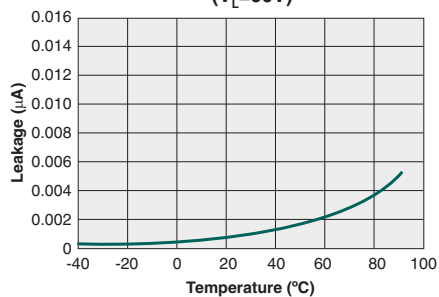
**Typical Load Current vs. Temperature**



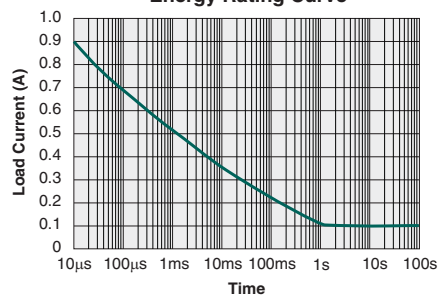
**Typical Blocking Voltage vs. Temperature**



**Typical Leakage vs. Temperature**  
Measured Across Pins 3&4  
( $V_L = 60\text{V}$ )



**Energy Rating Curve**



\*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

## Manufacturing Information

### Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC1017N	MSL 3

### ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

### Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
CPC1017N	260°C for 30 seconds

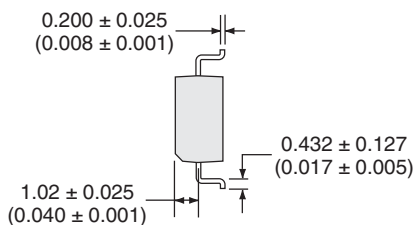
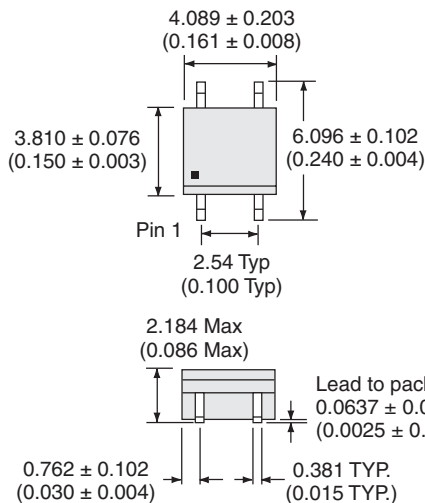
### Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

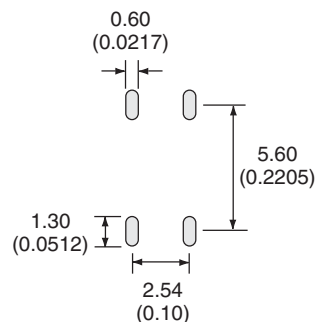


## MECHANICAL DIMENSIONS

### CPC1017N

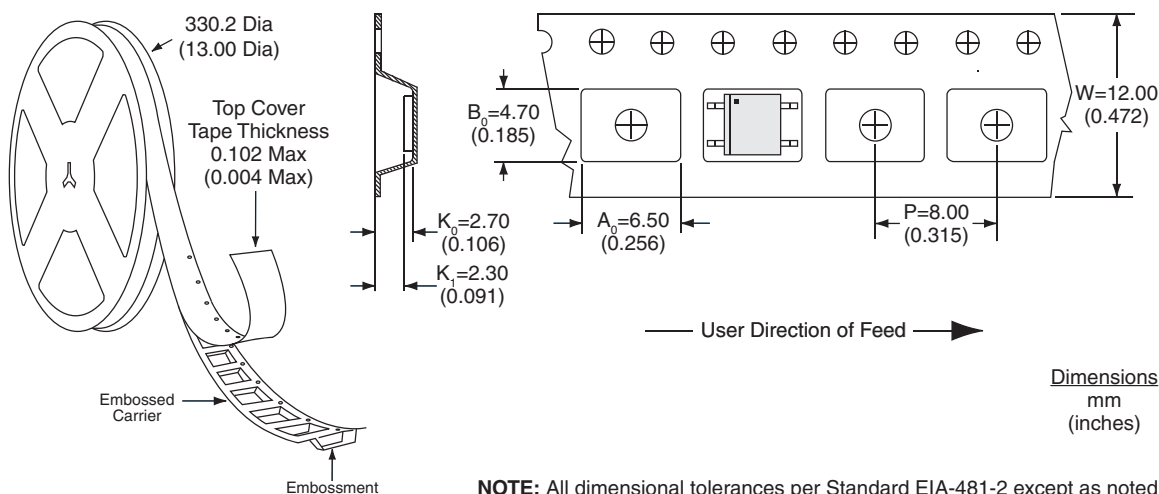


### Recommended PCB Land Pattern



Dimensions  
mm  
(inches)

### CPC1017NTR Tape & Reel



NOTE: All dimensional tolerances per Standard EIA-481-2 except as noted

For additional information please visit our website at: [www.ixysic.com](http://www.ixysic.com)

IXYS Integrated Circuits Division makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. Neither circuit patent licenses nor indemnity are expressed or implied. Except as set forth in IXYS Integrated Circuits Division's Standard Terms and Conditions of Sale, IXYS Integrated Circuits Division assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

The products described in this document are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or where malfunction of IXYS Integrated Circuits Division's product may result in direct physical harm, injury, or death to a person or severe property or environmental damage. IXYS Integrated Circuits Division reserves the right to discontinue or make changes to its products at any time without notice.